

Marvell To Showcase Cloud-Optimized Silicon Solutions At The 2022 OCP Global Summit

SANTA CLARA, Calif., Oct. 18, 2022 /PRNewswire/ -- Marvell Technology, Inc. (NASDAQ: MRVL), a leader in data infrastructure semiconductor solutions, today announced the details of its participation at the 2022 Open Compute Project (OCP) Global Summit.

When:

The OCP Global Summit begins today and continues through Thursday, October 20.

Where:

The OCP Summit will take place at the San Jose Convention Center in San Jose, Calif. with Marvell in booth A3.

Demonstrations:

At its booth, Marvell will showcase a comprehensive cloud-optimized silicon portfolio for data infrastructure, including compute, custom ASIC, networking, security, storage and memory solutions incorporating open source and open collaboration technologies that are advancing industry innovation:

- 5nm 112G Long-Reach SerDes for Custom Cloud Applications: Marvell's 112G Long-Reach SerDes is part of the company's industry-leading IP portfolio, offering breakthrough performance with the ability to operate at 112 Gbps across channels characterized by greater than 40dB insertion loss.
- Edge-to-Cloud Networking: A live edge-to-cloud network demonstration showing the end-to-end flow of a video edge use case, from edge camera to SD-WAN to border switch to top-of-rack switch to server. The demo showcases SONiC NOS operating on edge and data center switch platforms and features Marvell's [Teralynx® and Prestera® switch silicon](#), [Colorz® II ZR/ZR+ pluggable modules](#), [Alaska® Ethernet PHYs](#), and [Porrima™ and Alcor™ PAM4 DSPs](#) for optical modules.
- Edge-to-Cloud Accelerated Computing: Marvell's industry-leading [OCTEON® 10 Data Processing Unit \(DPU\) and OCTEON Fusion® 5G vRAN PCIe card](#), the industry's first no-compromise Open RAN solution.
- Active Electrical Cable (AEC) for Server/ToR Interconnect: 800G AECs based on [Marvell's Alaska® A family](#), the industry's first cloud-optimized 800G PAM4 DSPs for AECs.
- [LiquidSecurity® 2 \(LS2\) Hardware Security Module \(HSM\) Adapter](#): The industry's highest-performing, FIPS 140-certified HSM for ultimate protection of encrypted content in the cloud, providing 100,000 ECC operations per second, and up to one million keys and 45 partitions for multi-tenant scalability.
- Cloud-Optimized PCIe 5.0 NVMe SSD Controller: [Marvell's Bravera™ SC5 PCIe Gen 5.0 NVMe SSD](#) supporting multi-physical functions (PF) to optimize for different performance needs of cloud applications.
- Industry-First CXL Memory Pooling: Demonstration of the industry's first Compute Express Link (CXL) based memory-pooling across multiple CPUs/servers.

At the OCP-TAP booth #4, SiTime will demonstrate an open-source IEEE 1588 solution on [Marvell's Prestera DX 7300 Ethernet switching silicon](#).

Presentations:

Marvell Expo Talk: Cloud-Optimized Silicon for NVMe and CXL Powers the Scalable Data Center

Date: Tuesday, October 18

Time: 12:20 pm - 12:35 pm

Location: Expo Hall Stage

Marvell Speaker: Gary Kotzur, CTO, Storage Products Group

Marvell Executive Talk: The Next-Gen End-to-End Data Center Network

Date: Tuesday, October 18

Time: 2:30 pm - 2:55 pm

Location: Room 210AE

Marvell Speaker: John DaCosta, Vice President, Product Marketing, Switch Business Unit

Next Horizon for NVMe Storage Disaggregation (Storage Track)

Date: Wednesday, October 19

Time: 8:45 am - 9:00 am

Location: Room 210BF

Marvell Speaker: Gary Kotzur, CTO, Storage Products Group

Collaboration with The Open Programmable Infrastructure Project at 30,000 Ft Level (Networking

Track)**Date:** Wednesday, October 19**Time:** 11:00 am – 11:30 am**Location:** Room 210CG**Marvell Speaker:** Manoj Roge, Senior Director, Processor Business Unit**2.5D Heterogeneous Integration for Silicon Photonics Optical Engines (Special Focus: Optics Track)****Date:** Wednesday, October 19**Time:** 3:45 pm – 4:00 pm**Location:** Room 210AE**Marvell Speaker:** Radha Nagarajan, SVP & CTO, Optical and Copper Connectivity Group**BoW Implementations Update (Server Track)****Date:** Wednesday, October 19**Time:** 4:00 pm – 5:00 pm**Location:** Room 210BF**Marvell Speaker:** Mark Kuemerle, Vice President, Technology, ASIC Business Unit**Big Memory Panel (at CXL Forum @ OCP Summit)****Date:** Thursday, October 20**Time:** 9:55 am – 10:20 am**Location:** Room LL20BC**Marvell Speaker:** Shalesh Thusoo, VP CXL Product Development**Transforming Cloud Data Centers with CXL (at CXL Forum @ OCP Summit)****Date:** Thursday, October 20**Time:** 3:10 pm – 3:30 pm**Location:** Room LL20BC**Marvell Speaker:** Howard Borchew, Distinguished Engineer, Storage Products Group**About Marvell**

To deliver the data infrastructure technology that connects the world, we're building solutions on the most powerful foundation: our partnerships with our customers. Trusted by the world's leading technology companies for over 25 years, we move, store, process and secure the world's data with semiconductor solutions designed for our customers' current needs and future ambitions. Through a process of deep collaboration and transparency, we're ultimately changing the way tomorrow's enterprise, cloud, automotive, and carrier architectures transform—for the better.

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